



AN1111C Surface Mount IRED/1608 (h = 0.7 mm) Type

Features

Catares	
Package	1608 (h = 0.7 mm) type, Water clear epoxy
Product features taSheet4U.com	Small Size Outer Dimension 1.6 x 0.8 x 0.7mm (L x W x H) Total Output Power: 2mW TYP. (I _F =20mA) No lead package
Peak Wavelength	950nm
Half Intensity Angle	θ x = 125 deg., θ y = 150 deg.
Die materials	GaAs
Rank grouping parameter	Sorted by radiant intensity per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering, TTW (Through The Wave) soldering and manual soldering **Please refer to Soldering Conditions about soldering.
Taping and reel	4,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: ϕ 180mm
ESD	2kV (HBM)

Recommended Applications

Car Audio, Electric Household Appliances, OA/FA, PC/Peripheral Equipment, Other General Applications





Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings	Unit
Power Dissipation	Pd	75	mW
Forward Current	l _F	50	mA
Pulse Forward Current ¹	I _{FRM}	300	mA
Derating	I _F	0.67	mA/
(Ta=25 or higher)	I _{FRM}	4	mA/
DataSheeReverse Voltage	V_R	5	V
Operating Temperature	T _{opr}	-30 ~ +85	
Storage Temperature	T _{stg}	-40 ~ +100	

¹ IFRM Measurement condition : Pulse Width 100 μ s, Duty 1/100

Electro-Optical Characteristics

(Ta=25°C)

Item Conditions		Symbol	Charac	teristics	Unit
	Conditions		TVD	TVD 4.00	
Forward Voltage	I _F =20mA	V_{F}	V _F TYP.	1.22	v
	·		MAX.	1.4	
Reverse Current	V _R =5V	I_R	MAX.	10	μΑ
Dodiant Intensity	1 20m A	I _E	MIN.	0.2	mW/sr
Radiant Intensity	I _F =20mA		TYP.	0.28	TTIVV/SI
Total Output Power	I _F =20mA	Ро	TYP.	2	mW
Peak Wavelength	I _F =20mA	р	TYP.	950	nm
Spectral Half-width	I _F =20mA		TYP.	45	nm
Half Intensity Angle	1 –20m Λ	2 1/2	TYP.	125(θ x)	doa
Half Intensity Angle	I _F =20mA			150(<i>θ</i> y)	deg.
Cut off Fraguerov	$I_F=20mA_{DC}\pm5mA$,	fc	MIN.	-	MHz
Cut-off Frequency	-3db from 0.1MHz		TYP.	0.5	IVIMZ
Response Time	I _F =20mA	tr/tf	TYP.	700	ns





Radiant Intensity Rank

(Ta=25°C)

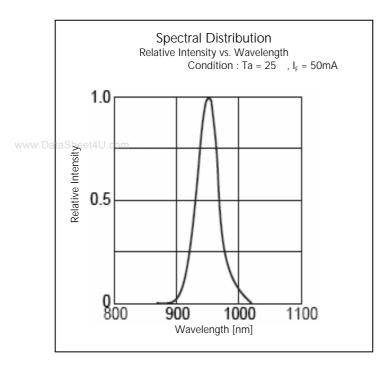
	Rank	I _E (mW/sr)		Condition
		MIN.	MAX.	Condition
www.Daf	A aSheet4U.com	0.20	0.40	
	В	0.28	0.56	I _F = 20mA
	С	0.40	0.80	

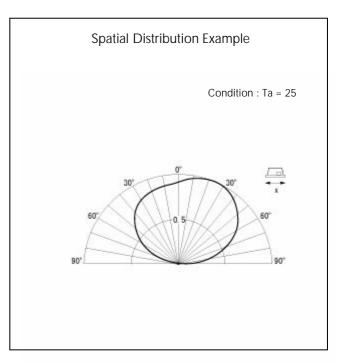
Please contact our sales staff concerning rank designation.

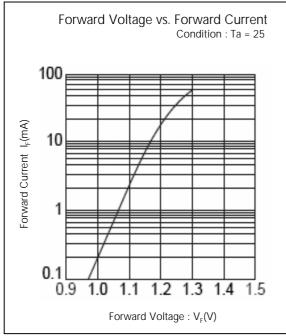


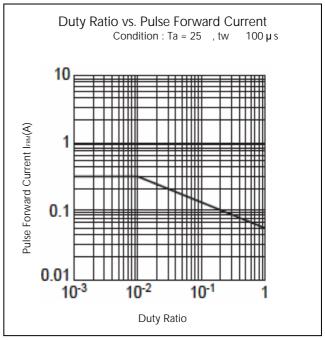


Technical Data





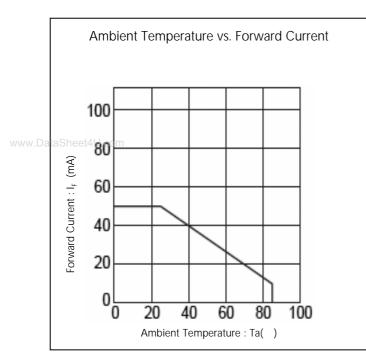


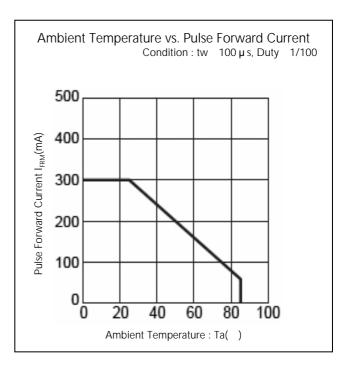


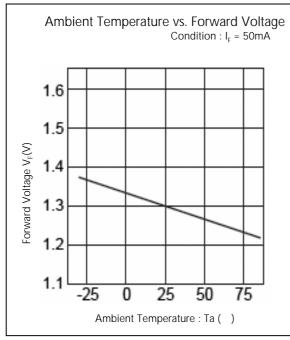


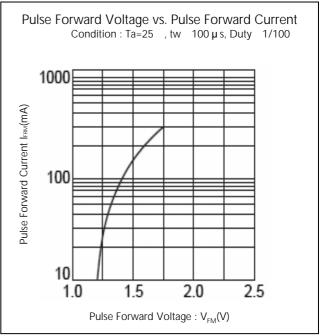


Technical Data





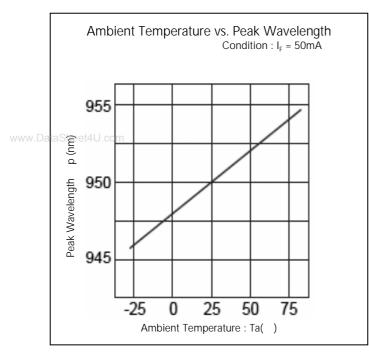


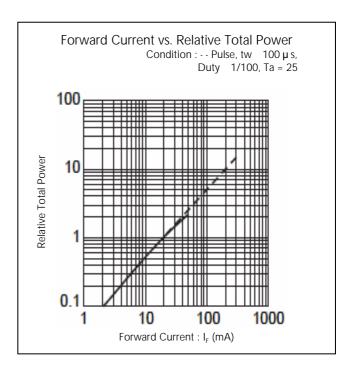


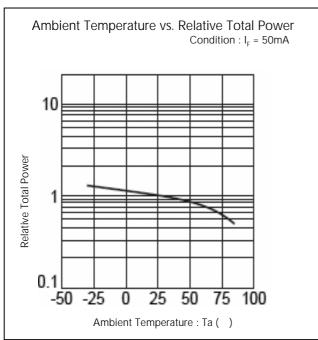




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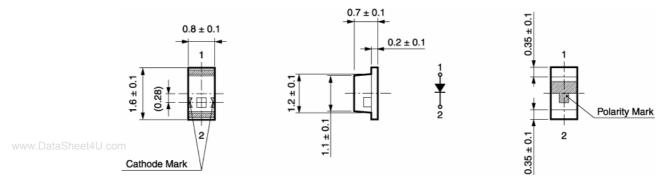




Package Dimensions

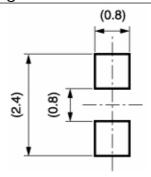
(Unit: mm)

Weight: (1.40)mg



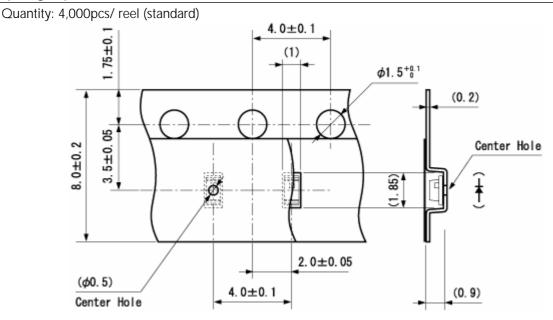
Recommended Soldering Pattern

(Unit: mm)



Taping Specification

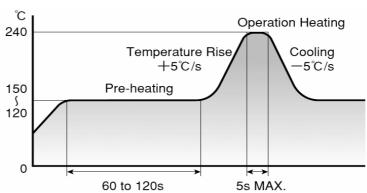
(Unit: mm)







Reflow Soldering Conditions



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- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized.

TTW (Through The Wave) soldering Conditions

Pre-heating	120 ~ 150 60 s ~ 120 s	
Solder Bath Temp.	260	(MAX.)
Dipping Time	5 s	(MAX.)

- 1) The dip soldering process shall be 2 times maximum.
- 2) The product shall be cooled to normal temperature before the second dipping process.

Manual Soldering Conditions

Iron tip temp.	280	(MAX.) (30 W Max.)
Soldering time and frequency	3 s 1 time	(MAX.) (MAX.)





Reliability Testing Result

	oility Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
	om Temp. rating Life	EIAJ ED- 4701/100(101)	Ta = 25°C, IF = Maxium Rated Current	1,000 h	0/25
Res	sistance to	EIAJ ED-	(Pretreatment) Individual standard (Reflow Soldering) Pre-heating 150°C 120s →Operating Heating 240°C 5s	-	0/25
Sold .DataSheet4L	J.com	4701/300(301)	(Pretreatment) Individual standard (Reflow Soldering) Pre-heating 180°C 120s →Operating Heating 260°C 5s	-	0/25
Tempe	rature Cycling	EIAJ ED- 4701/100(105)	Minimum Rated Storage Temperature(30min) Normal Temperature(15min) Maximum Rated Storage Temperature(30min) Normal Temperature(15min)	5 cycles	0/25
	High Temp. orage Life	EIAJ ED- 4701/100(103)	$Ta = 60 \pm 2^{\circ}C$, RH = $90 \pm 5\%$	1,000 h	0/25
	gh Temp. orage Life	EIAJ ED- 4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
	w Temp. orage Life	EIAJ ED- 4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
	bration, le Frequency	EIAJ ED- 4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Radiant Intensity	l _E	IF Value of each product Radiant Intensity	Testing Min. Value < Initial Value x 0.5
Forward Voltage	VF	IF Value of each product Forward Voltage	Testing Max. Value > Spec. Max. Value x 1.2
Reverse Current	I R	VR = Maximum Rated Reverse Voltage V	Testing Max. Value ≧ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	No notable, decoloration, deformation and cracking



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